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A Unit of Teledyne Electronic Technologies

#### Part Number Description

LPBD100

.25A, 100Vdc dual solid-state relay

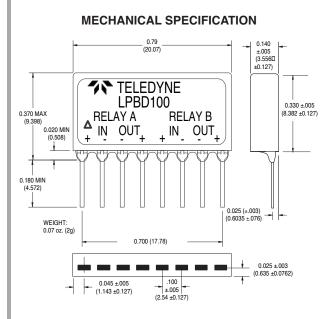
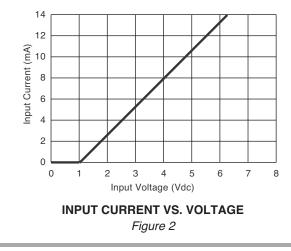


Figure 1 – LPBD100 relay; dimensions in inches (mm)

### **INPUT (CONTROL) SPECIFICATIONS**

	Min	Max	Units
Control Voltage Range	4.0	7.0	Vdc
(See Note 1)			
Input Current @ 5 Vdc (See Figure 2)		12	mAdc
Must Turn-On Voltage		0.8	Vdc
Must Turn-Off Voltage	4.0		Vdc
Must Turn-On Current		50	μAdc
Reverse Voltage	7		Vdc





### FEATURES/BENEFITS

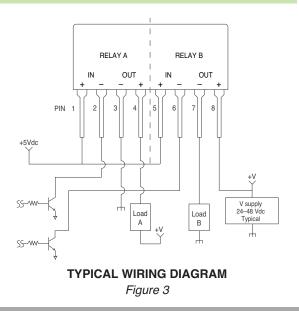
- · Compact SIP plastic package
- · Dual output: two relays in one package
- · Normally closed output
- Low voltage drop

### DESCRIPTION

The LPBD100 is a dual-output 100Vdc plastic relay. The relay output-switch contacts are normally closed and will conduct the load current until a voltage is applied to the relay input. With 4 volts or more at the relay input, the output-switch contacts open and the relay no longer conducts. The LPBD100 assembly contains two independent relays, completely isolated from each other, in a single in-line package (SIP). The relays provide optical isolation between input and output terminals. Each relay output circuit uses a pair of depletion-mode MOSFETs for reliable operation.

### **APPLICATIONS**

- Interface applications
- Aircraft flight control systems
- A.T.E
- · 28Vdc aircraft instrumentation systems



## **Series LPBD100**

### 250mA, 100Vdc Normally Closed Dual Relay



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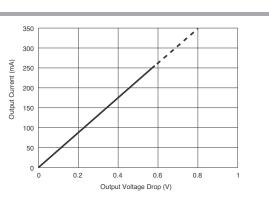
# **Series LPBD100**

**OUTPUT (LOAD) SPECIFICATION** 

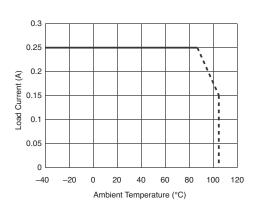
Min	Max	Units
Load Voltage Rating	100	Vdc
Load Current Range (See Figure	5) 0.25	Adc
Transient Blocking Voltage	200	Vdc
Output Capacitance@ 25Vdc	120	pF
On-State Voltage Drop (See Figur	e 4) 1.25	Vdc
On Resistance	5.0	Ohm
Off-State Leakage Current (100 V	′dc) 10	μAdc
Turn-On Time	0.5	ms
Turn-Off Time	2.5	ms

### **ENVIRONMENTAL SPECIFICATION**

		Min	Мах	Units
Operating Tempera	ture	-40	+85	°C
Storage Temperatur	re	-55	+100	°C
Junction Temperatu	re		125	°C
Thermal Resistance	е			
(Junction to Ambier	nt) each	n relay	120	°C/W
Shock			1500	g
Vibration			100	g
Dielectric Strength		500		Vac
Insulation Resistan	се			
(@500 Vdc)		10 <sup>9</sup>		Ohm
Input to Output Cap	acitanc	e	5	pF
Resistance to				
Soldering Heat	MIL STD 202, method 210			
Solderability	MIL STD 202, method 208			
Thermal Shock	MIL S	TD 202, me	ethod 107	
Altitude		55,000		ft
HAST	JDEC	Test Metho	od A110	
	, no power			
	арр	lied, 50 ho	urs	



### OUTPUT CURRENT VS. VOLTAGE DROP Figure 4



### LOAD CURRENT VS. AMBIENT TEMPERATURE

Figure 5

NOTES:

- 1. For input voltages greater than 7 volts, use an external resistor in series with the relay input. Rext. = (Vin–7 Vdc)/0.012 Amps
- Unless otherwise specified: conformance testing is at room temperature; the input voltage is 5Vdc or zero volts as required; the output load is 48Vdc, 0.25 amp.
- Relay input voltage transitions should be less than 1.0 millisecond.
- 4. Maximum load current ratings are with the relay in free air and
- soldered to a printed circuit board.
  Timing is measured from the input voltage transition to the 10% or 90% point on the output voltage off-to-on or on-to-off transition. Rise and fall times are from the 10% to 90% points on the output voltage transition.

